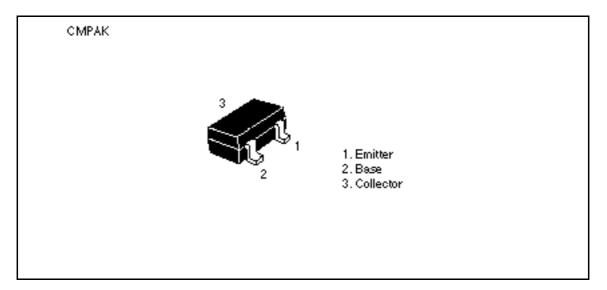
Silicon NPN Epitaxial

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Application

UHF RF amplifier

Outline





Absolute Maximum Ratings (Ta = 25° C)

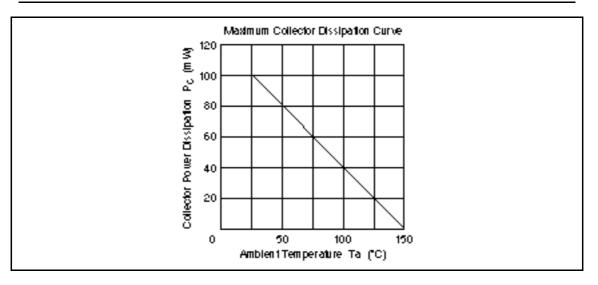
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	30	V
Collector to emitter voltage	V _{CEO}	25	V
Emitter to base voltage	V _{EBO}	3	V
Collector current	I _c	20	mA
Collector power dissipation	Pc	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector cutoff current	I _{CBO}	—		0.3	μA	$V_{CB} = 15 \text{ V}, I_{E} = 0$
	I _{CEO}	_	_	10	μA	V_{ce} = 25 V, R_{be} =
Emitter cutoff current	I _{EBO}	_	_	1.0	μA	$V_{EB} = 3 V, I_{C} = 0$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	5.0	V	$I_{c} = 10 \text{ mA}, I_{B} = 1 \text{ mA}$
DC current transfer ratio	h_{FE}	50		180		$V_{ce} = 5 \text{ V}, \text{ I}_c = 2 \text{ mA}$
Collector output capacitance	Cob	_	0.6	0.9	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1MHz$
Gain bandwidth product	f _T	0.7	1.0	_	GHz	$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 2 \text{ mA}$
Power gain	PG	10	15	_	dB	V_{cc} = 4 V, I _c = 2 mA, f = 900 MHz
Noise figure	NF	_	3.0	4.5	dB	V_{cc} = 4 V, I _c = 2 mA, f = 900 MHz
AGC voltage	V_{AGC}	1.8	_	2.7	V	$V_{cc} = 4 V, I_c = 2 mA,$ f = 900 MHz, P _{in} = -50 dBm, GR = 30 dB

Note: Marking is "UI-".

See characteristic curves of 2SC4229.



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